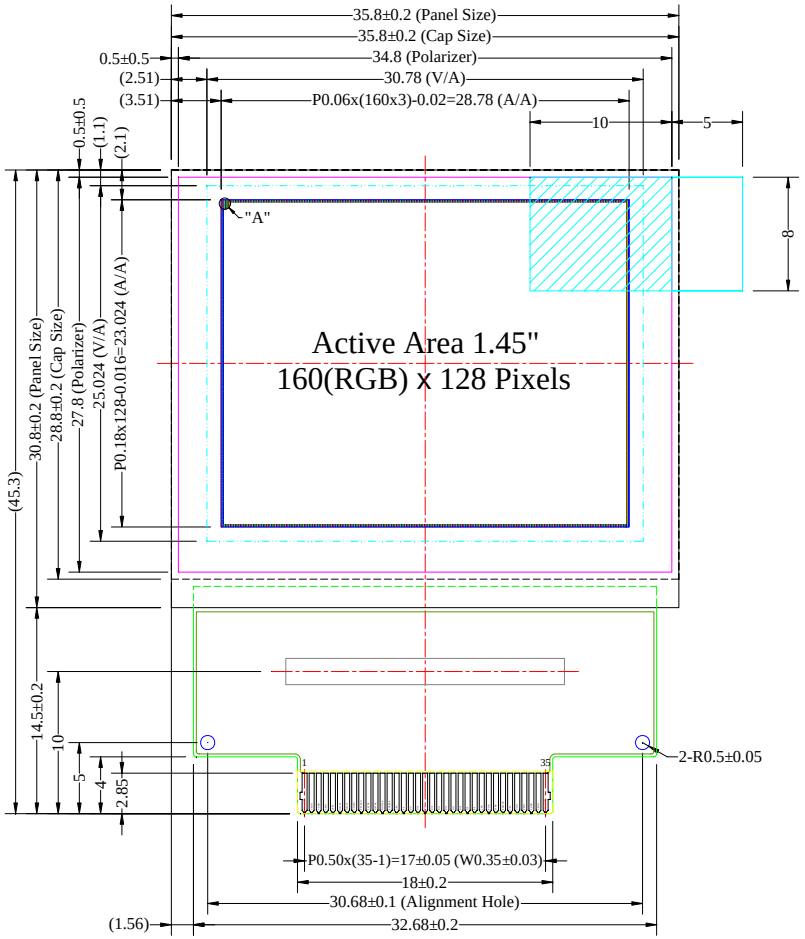
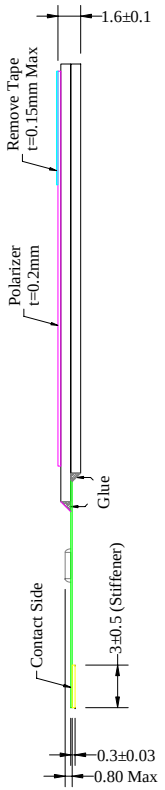
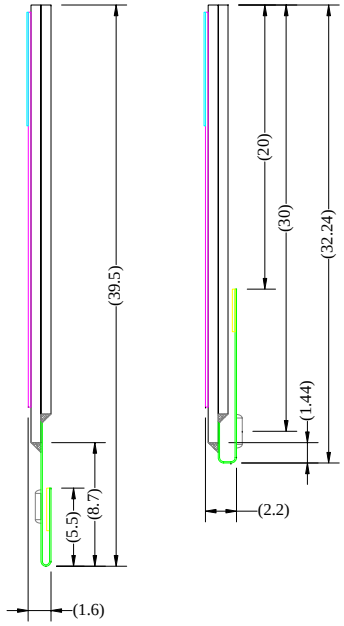
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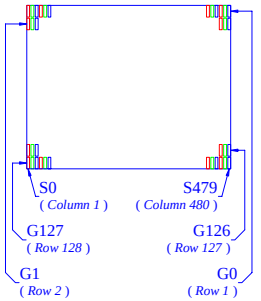
Item	Date	Remark
A	20060320	Original Drawing
B	20061129	Modify Interface Notes
C	20080609	Update Applicable COF Number & Pin Definition
D	20120426	Remove Single-side Tape

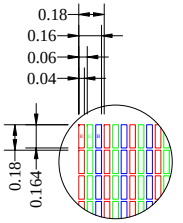






(Reference Mechnical Design)





Detail "A"
Scale (10:1)

Pin	Symbol
1	N.C. (GND)
2	VSDH
3	VDDH
4	VSSH
5	IREF
6	OSCA2
7	OSCA1
8	VDDIO
9	VSYNCO
10	VSYNC
11	HSYNC
12	DOTCLK
13	ENABLE
14	CPU
15	PS
16	D17
17	D16
18	D15
19	D14
20	D13
21	D12
22	D11
23	D10
24	D9
25	RS
26	CSB
27	RDB
28	WRB
29	RESETB
30	VSS
31	VDD
32	VSSH
33	VDDH
34	VSDH
35	N.C. (GND)

Notes:

1. Driver IC: SEPS525
2. Die Size: 19660um x 1850um
3. COF Number: SEPS525F00 / UT-0825-F01
4. Interface:
   8-/9-bit 80XX Parallel, 4-wire SPI, 6-bit RGB I/F
5. General Tolerance: ±0.30
6. The total thickness (1.70 Max) is without polarizer protective film & remove tape.
   The actual assembled total thickness with above materials should be 1.95 Max

Customer Approval Signature	WiseChip Semiconductor Inc.						Drawing Number	Rev.
							DFE6028CNCF06	D
	Unless Otherwise Specified		Title	UG-6028GDEAF01 Folding Type OEL Display Module Pixel Number: 160(RGB) x 128, 262144 Colors, COF Package			Material	
	Unit	mm					Soda Lime / Polyimide	
	General Roughness							
	Tolerance			Drawn	E.E.	Panel / E.	P.M.	
	Dimension	±0.3	By	Dora Yang	Sean Lai	Ivy Lo	Sean Lin	Scale / Sheet / Size
	Angle	±1	Date	20120426	20120426	20120426	20120426	1:1 / 1 of 1 / A3